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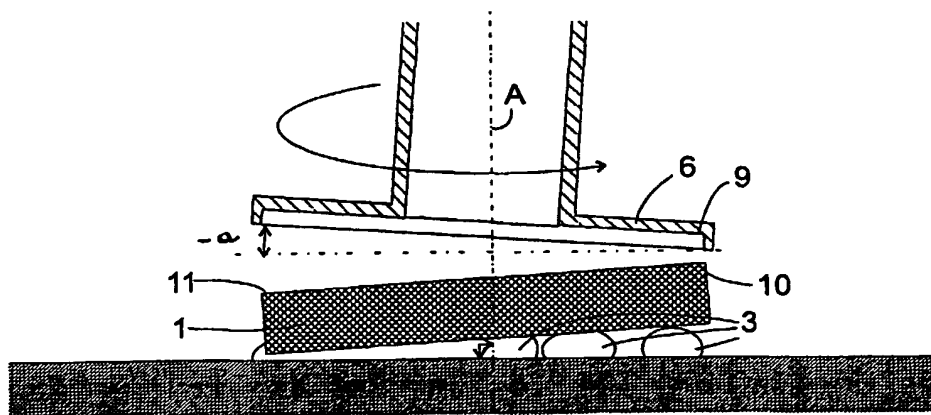
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- (71) Applicant (for all designated States except US): **MARCONI COMMUNICATIONS GMBH** [DE/DE]; Gerberstrasse 33, 71520 Backnang (DE).
- (72) Inventors; and
- (75) Inventors/Applicants (for US only): **KONRATH, Willibald** [DE/DE]; Eichendorffweg 17, 71544 Weissach im Tal (DE). **SCHMELCHER, Haiko** [DE/DE]; Lindenstr. 36, 74427 Fichtenberg (DE). **SCHOLL, Klaus** [DE/DE]; Stresemannstr. 30/5, 71522 Backnang (DE). **MULLER, Ulf** [DE/DE]; Elbestrasse 30, 71522 Backnang (DE).
- (74) Agents: **COCKAYNE, Gillian** et al.; Marconi Intellectual Property, Crompton Close, Basildon Essex SS14 3BA (GB).
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(54) Title: METHOD FOR GLUING A CIRCUIT COMPONENT TO A CIRCUIT SUBSTRATE



(57) Abstract: A circuit component (1) is glued to the circuit substrate (2) by the following steps: a) seizing a circuit component (1) using a gripper (4); b) moving the gripper (4) towards the surface of the circuit substrate (2) up to a target distance from the surface at which adhesive (3) applied between the circuit component (1) and the circuit substrate (2) is pressed; c) releasing the circuit component (1) and removing the gripper (4) from the circuit component (1); d) turning the gripper (4) around an axis (A) perpendicular to the surface of the circuit substrate (2); e) moving the gripper (4) into the target distance again; and f) removing the gripper (4) again.



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